

MC74AC139, MC74ACT139

Dual 1-of-4 Decoder/Demultiplexer

The MC74AC139/74ACT139 is a high-speed, dual 1-of-4 decoder/demultiplexer. The device has two independent decoders, each accepting two inputs and providing four mutually-exclusive active-LOW outputs. Each decoder has an active-LOW Enable input which can be used as a data input for a 4-output demultiplexer. Each half of the MC74AC139/74ACT139 can be used as a function generator providing four minterms of two variables.

- Multifunctional Capability
- Two Completely Independent 1-of-4 Decoders
- Active LOW Mutually Exclusive Outputs
- Outputs Source/Sink 24 mA
- 'ACT139 Has TTL Compatible Inputs

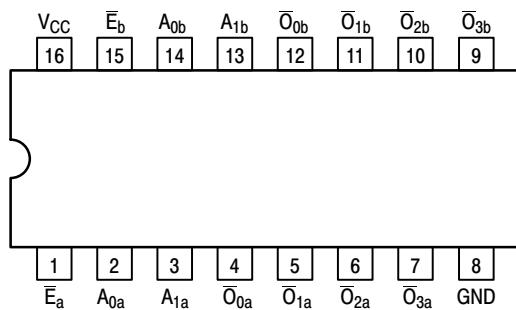


Figure 1. Pinout: 16-Lead Packages Conductors
(Top View)

PIN ASSIGNMENT

PIN	FUNCTION
A ₀ , A ₁	Address Inputs
Ē	Enable Inputs
O ₀ –O ₃	Outputs

TRUTH TABLE

Inputs			Outputs			
Ē	A ₀	A ₁	O ₀	O ₁	O ₂	O ₃
H	X	X	H	H	H	H
L	L	L	L	H	H	H
L	H	L	H	L	H	H
L	L	H	H	H	L	H
L	H	H	H	H	H	L

H = HIGH Voltage Level

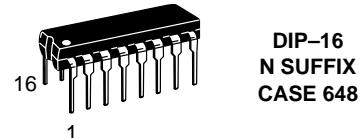
L = LOW Voltage Level

X = Immaterial

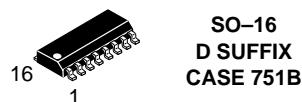


ON Semiconductor®

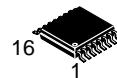
<http://onsemi.com>



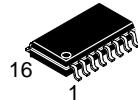
DIP-16
N SUFFIX
CASE 648



SO-16
D SUFFIX
CASE 751B



TSSOP-16
DT SUFFIX
CASE 948F



EIAJ-16
M SUFFIX
CASE 966

ORDERING INFORMATION		
Device	Package	Shipping
MC74AC139N	PDIP-16	25 Units/Rail
MC74ACT139N	PDIP-16	25 Units/Rail
MC74AC139D	SOIC-16	48 Units/Rail
MC74ACT139D	SOIC-16	48 Units/Rail
MC74AC139DR2	SOIC-16	2500 Tape & Reel
MC74ACT139DR2	SOIC-16	2500 Tape & Reel
MC74AC139DT	TSSOP-16	96 Units/Rail
MC74ACT139DT	TSSOP-16	96 Units/Rail
MC74AC139DTR2	TSSOP-16	2500 Tape & Reel
MC74AC139M	EIAJ-16	50 Units/Rail
MC74ACT139M	EIAJ-16	50 Units/Rail
MC74AC139MEL	EIAJ-16	2000 Tape & Reel
MC74ACT139MEL	EIAJ-16	2000 Tape & Reel

DEVICE MARKING INFORMATION

See general marking information in the device marking section on page 6 of this data sheet.

MC74AC139, MC74ACT139

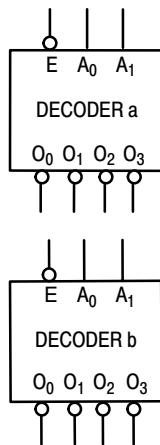
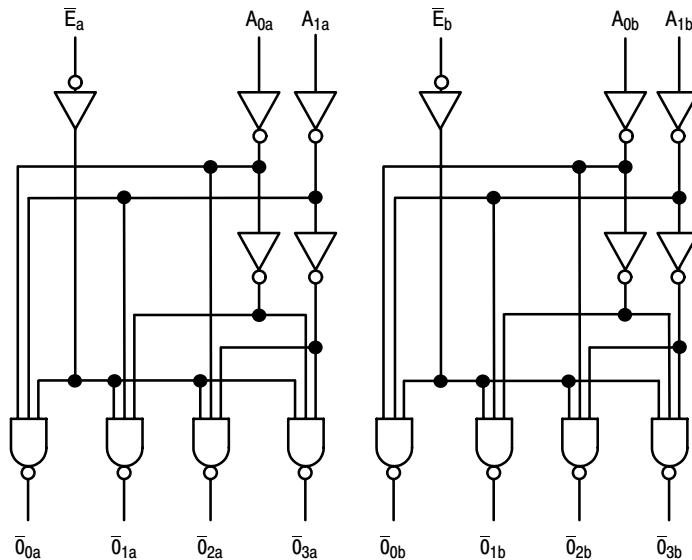


Figure 2. Logic Symbol



NOTE: This diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Figure 3. Logic Diagram

FUNCTIONAL DESCRIPTION

The MC74AC139/74ACT139 is a high-speed dual 1-of-4 decoder/demultiplexer. The device has two independent decoders, each of which accepts two binary weighted inputs (A_0-A_1) and provides four mutually exclusive active-LOW outputs ($\bar{O}_0-\bar{O}_3$). Each decoder has an active-LOW enable (\bar{E}). When \bar{E} is HIGH all outputs are forced HIGH. The enable can be used as the data input for a 4-output demultiplexer application. Each half of the MC74AC139/74ACT139 generates all four minterms of two variables. These four minterms are useful in some applications, replacing multiple gate functions as shown in Figure 4, and thereby reducing the number of packages required in a logic network.

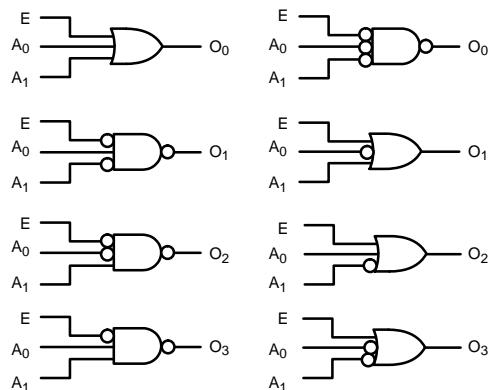


Figure 4. Gate Functions (Each Half)

MC74AC139, MC74ACT139

MAXIMUM RATINGS*

Symbol	Parameter	Value	Unit
V _{CC}	DC Supply Voltage (Referenced to GND)	−0.5 to +7.0	V
V _{IN}	DC Input Voltage (Referenced to GND)	−0.5 to V _{CC} +0.5	V
V _{OUT}	DC Output Voltage (Referenced to GND)	−0.5 to V _{CC} +0.5	V
I _{IN}	DC Input Current, per Pin	±20	mA
I _{OUT}	DC Output Sink/Source Current, per Pin	±50	mA
I _{CC}	DC V _{CC} or GND Current per Output Pin	±50	mA
T _{stg}	Storage Temperature	−65 to +150	°C

*Maximum Ratings are those values beyond which damage to the device may occur. Functional operation should be restricted to the Recommended Operating Conditions.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Typ	Max	Unit
V _{CC}	Supply Voltage	'AC	2.0	5.0	V
		'ACT	4.5	5.0	
V _{IN} , V _{OUT}	DC Input Voltage, Output Voltage (Ref. to GND)	0	—	V _{CC}	V
t _r , t _f	Input Rise and Fall Time (Note 1) 'AC Devices except Schmitt Inputs	V _{CC} @ 3.0 V	—	150	ns/V
		V _{CC} @ 4.5 V	—	40	
		V _{CC} @ 5.5 V	—	25	
t _r , t _f	Input Rise and Fall Time (Note 2) 'ACT Devices except Schmitt Inputs	V _{CC} @ 4.5 V	—	10	ns/V
		V _{CC} @ 5.5 V	—	8.0	
T _J	Junction Temperature (PDIP)	—	—	140	°C
T _A	Operating Ambient Temperature Range	−40	25	85	°C
I _{OH}	Output Current – High	—	—	−24	mA
I _{OL}	Output Current – Low	—	—	24	mA

1. V_{IN} from 30% to 70% V_{CC}; see individual Data Sheets for devices that differ from the typical input rise and fall times.

2. V_{IN} from 0.8 V to 2.0 V; see individual Data Sheets for devices that differ from the typical input rise and fall times.

MC74AC139, MC74ACT139

DC CHARACTERISTICS

Symbol	Parameter	V_{CC} (V)	74AC		74AC	Unit	Conditions
			$T_A = +25^\circ C$		$T_A = -40^\circ C$ to $+85^\circ C$		
			Typ	Guaranteed Limits			
V_{IH}	Minimum High Level Input Voltage	3.0 4.5 5.5	1.5 2.25 2.75	2.1 3.15 3.85	2.1 3.15 3.85	V	$V_{OUT} = 0.1 V$ or $V_{CC} - 0.1 V$
V_{IL}	Maximum Low Level Input Voltage	3.0 4.5 5.5	1.5 2.25 2.75	0.9 1.35 1.65	0.9 1.35 1.65	V	$V_{OUT} = 0.1 V$ or $V_{CC} - 0.1 V$
V_{OH}	Minimum High Level Output Voltage	3.0 4.5 5.5	2.99 4.49 5.49	2.9 4.4 5.4	2.9 4.4 5.4	V	$I_{OUT} = -50 \mu A$
		3.0 4.5 5.5	— — —	2.56 3.86 4.86	2.46 3.76 4.76	V	$*V_{IN} = V_{IL}$ or V_{IH} $-12 mA$ I_{OH} $-24 mA$ $-24 mA$
		3.0 4.5 5.5	0.002 0.001 0.001	0.1 0.1 0.1	0.1 0.1 0.1	V	$I_{OUT} = 50 \mu A$
		3.0 4.5 5.5	— — —	0.36 0.36 0.36	0.44 0.44 0.44	V	$*V_{IN} = V_{IL}$ or V_{IH} $12 mA$ I_{OL} $24 mA$ $24 mA$
I_{IN}	Maximum Input Leakage Current	5.5	—	± 0.1	± 1.0	μA	$V_I = V_{CC}$, GND
I_{OLD}	†Minimum Dynamic Output Current	5.5	—	—	75	mA	$V_{OLD} = 1.65 V$ Max
I_{OHD}		5.5	—	—	-75	mA	$V_{OHD} = 3.85 V$ Min
I_{CC}	Maximum Quiescent Supply Current	5.5	—	8.0	80	μA	$V_{IN} = V_{CC}$ or GND

*All outputs loaded; thresholds on input associated with output under test.

†Maximum test duration 2.0 ms, one output loaded at a time.

NOTE: I_{IN} and I_{CC} @ 3.0 V are guaranteed to be less than or equal to the respective limit @ 5.5 V V_{CC} .

AC CHARACTERISTICS (For Figures and Waveforms – See Section 3 of the ON Semiconductor FACT Data Book, DL138/D)

Symbol	Parameter	V_{CC}^* (V)	74AC			74AC	Unit	Fig. No.
			$T_A = +25^\circ C$ $C_L = 50 pF$			$T_A = -40^\circ C$ to $+85^\circ C$ $C_L = 50 pF$		
			Min	Typ	Max	Min		
t_{PLH}	Propagation Delay A_n to \bar{O}_n	3.3 5.0	4.0 3.0	8.0 6.5	11.5 8.5	3.5 2.5	13 9.5	ns 3-6
t_{PHL}	Propagation Delay A_n to \bar{O}_n	3.3 5.0	3.0 2.5	7.0 5.5	10 7.5	2.5 2.0	11 8.5	ns 3-6
t_{PLH}	Propagation Delay \bar{E}_n to \bar{O}_n	3.3 5.0	4.5 3.5	9.5 7.0	12 8.5	3.5 3.0	13 10	ns 3-6
t_{PHL}	Propagation Delay \bar{E}_n to \bar{O}_n	3.3 5.0	4.0 2.5	8.0 6.0	10 7.5	3.0 2.5	11 8.5	ns 3-6

*Voltage Range 3.3 V is 3.3 V ± 0.3 V.

*Voltage Range 5.0 V is 5.0 V ± 0.5 V.

MC74AC139, MC74ACT139

DC CHARACTERISTICS

Symbol	Parameter	V_{CC} (V)	74ACT		74ACT		Unit	Conditions		
			$T_A = +25^\circ C$		$T_A = -40^\circ C \text{ to } +85^\circ C$					
			Typ	Guaranteed Limits	Typ	Guaranteed Limits				
V_{IH}	Minimum High Level Input Voltage	4.5 5.5	1.5 1.5	2.0 2.0	2.0 2.0	2.0 2.0	V	$V_{OUT} = 0.1 V$ or $V_{CC} - 0.1 V$		
V_{IL}	Maximum Low Level Input Voltage	4.5 5.5	1.5 1.5	0.8 0.8	0.8 0.8	0.8 0.8	V	$V_{OUT} = 0.1 V$ or $V_{CC} - 0.1 V$		
V_{OH}	Minimum High Level Output Voltage	4.5 5.5	4.49 5.49	4.4 5.4	4.4 5.4	4.4 5.4	V	$I_{OUT} = -50 \mu A$		
		4.5 5.5	— —	3.86 4.86	3.76 4.76	3.76 4.76	V	$*V_{IN} = V_{IL} \text{ or } V_{IH}$ $-24 mA$ $I_{OH} \quad -24 mA$		
V_{OL}	Maximum Low Level Output Voltage	4.5 5.5	0.001 0.001	0.1 0.1	0.1 0.1	0.1 0.1	V	$I_{OUT} = 50 \mu A$		
		4.5 5.5	— —	0.36 0.36	0.44 0.44	0.44 0.44	V	$*V_{IN} = V_{IL} \text{ or } V_{IH}$ $24 mA$ $I_{OL} \quad 24 mA$		
I_{IN}	Maximum Input Leakage Current	5.5	—	± 0.1	± 1.0	± 1.0	μA	$V_I = V_{CC}, GND$		
ΔI_{CCT}	Additional Max. I_{CC} /Input	5.5	0.6	—	1.5	1.5	mA	$V_I = V_{CC} - 2.1 V$		
I_{OLD}	†Minimum Dynamic Output Current	5.5	—	—	75	75	mA	$V_{OLD} = 1.65 V$ Max		
I_{OHD}		5.5	—	—	—75	—75	mA	$V_{OHD} = 3.85 V$ Min		
I_{CC}	Maximum Quiescent Supply Current	5.5	—	8.0	80	80	μA	$V_{IN} = V_{CC}$ or GND		

*All outputs loaded; thresholds on input associated with output under test.

†Maximum test duration 2.0 ms, one output loaded at a time.

AC CHARACTERISTICS (For Figures and Waveforms – See Section 3 of the ON Semiconductor FACT Data Book, DL138/D)

Symbol	Parameter	V_{CC}^* (V)	74ACT			74ACT		Unit	Fig. No.		
			$T_A = +25^\circ C$ $C_L = 50 pF$			$T_A = -40^\circ C$ $to +85^\circ C$ $C_L = 50 pF$					
			Min	Typ	Max	Min	Max				
t_{PLH}	Propagation Delay A_n to \bar{O}_n	5.0	1.5	6.0	8.5	1.5	9.5	ns	3-6		
t_{PHL}	Propagation Delay A_n to \bar{O}_n	5.0	1.5	6.0	9.5	1.5	10.5	ns	3-6		
t_{PLH}	Propagation Delay \bar{E}_n to \bar{O}_n	5.0	2.5	7.0	10.0	2.0	11.0	ns	3-6		
t_{PHL}	Propagation Delay \bar{E}_n to \bar{O}_n	5.0	2.0	7.0	9.5	1.5	10.5	ns	3-6		

*Voltage Range 5.0 V is $5.0 V \pm 0.5 V$.

CAPACITANCE

Symbol	Parameter	Value Typ	Unit	Test Conditions
C_{IN}	Input Capacitance	4.5	pF	$V_{CC} = 5.0 V$
C_{PD}	Power Dissipation Capacitance	40	pF	$V_{CC} = 5.0 V$

MC74AC139, MC74ACT139

MARKING DIAGRAMS

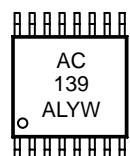
DIP-16



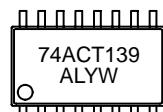
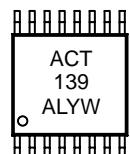
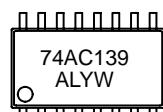
SO-16



TSSOP-16



EIAJ-16



A = Assembly Location
WL, L = Wafer Lot
YY, Y = Year
WW, W = Work Week

MC74AC139, MC74ACT139

PACKAGE DIMENSIONS

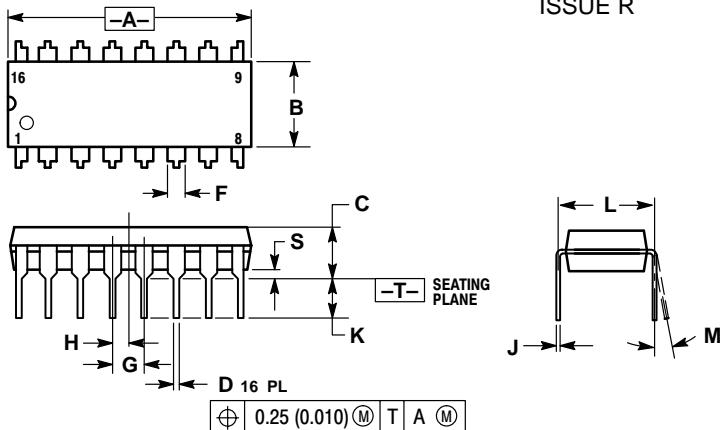
PDIP-16

N SUFFIX

16 PIN PLASTIC DIP PACKAGE

CASE 648-08

ISSUE R

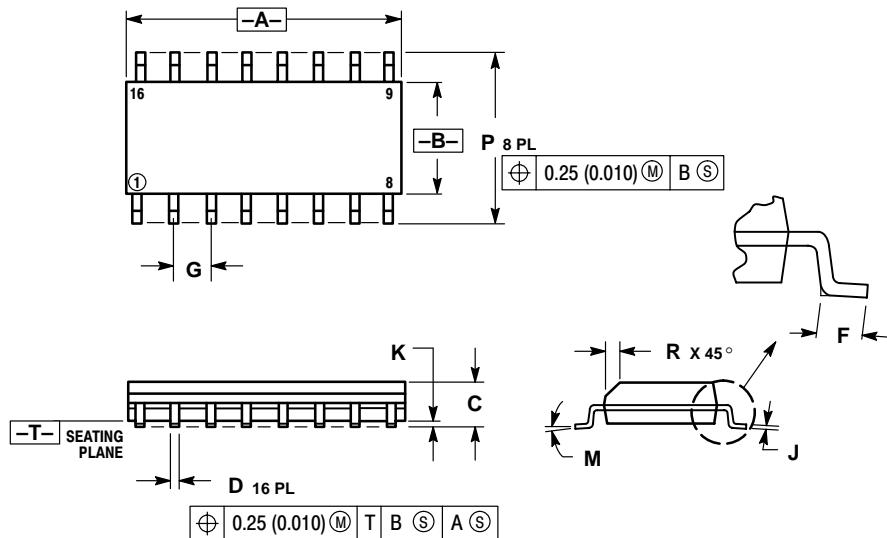


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0°	10°	0°	10°
S	0.020	0.040	0.51	1.01

SO-16
D SUFFIX
16 PIN PLASTIC SOIC PACKAGE
CASE 751B-05
ISSUE J



NOTES:

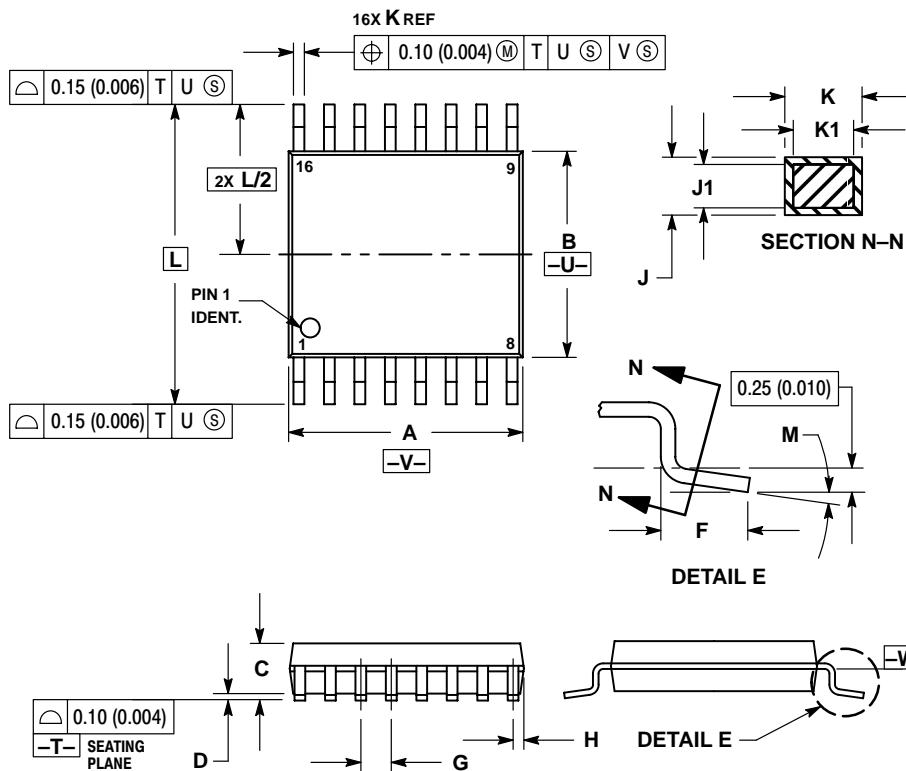
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.80	10.00	0.386	0.393
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

MC74AC139, MC74ACT139

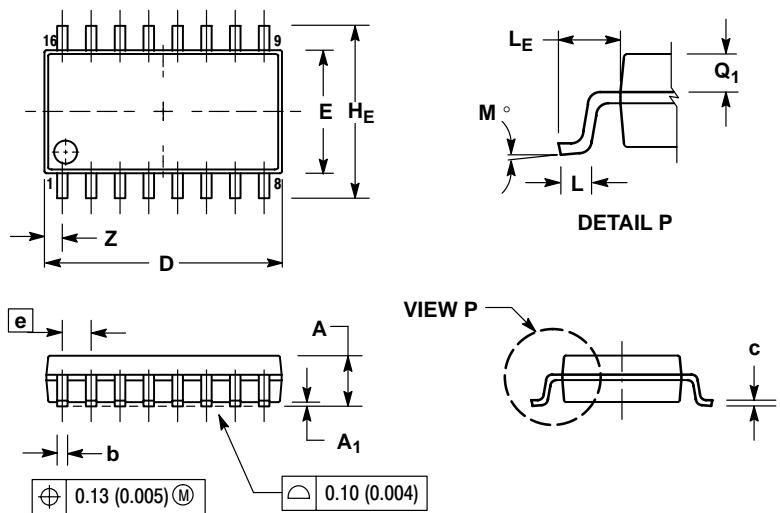
PACKAGE DIMENSIONS

**TSSOP-16
DT SUFFIX
16 PIN PLASTIC TSSOP PACKAGE
CASE948F-01
ISSUE O**



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DIMENSION A DOES NOT INCLUDE MOLD FLASH. PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
 4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
 5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
 6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
 7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

**EIAJ-16
M SUFFIX
16 PIN PLASTIC EIAJ PACKAGE
CASE966-01
ISSUE O**



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
 4. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
 5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

Notes

Notes

Notes

ON Semiconductor and  are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer.

PUBLICATION ORDERING INFORMATION

Literature Fulfillment:

Literature Distribution Center for ON Semiconductor
P.O. Box 5163, Denver, Colorado 80217 USA
Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada
Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada
Email: ONlit@hibbertco.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada

JAPAN: ON Semiconductor, Japan Customer Focus Center
4-32-1 Nishi-Gotanda, Shinagawa-ku, Tokyo, Japan 141-0031
Phone: 81-3-5740-2700
Email: r14525@onsemi.com

ON Semiconductor Website: <http://onsemi.com>

For additional information, please contact your local
Sales Representative.